COMBINED DECLARATION AND POWER OF ATTORNEY

As the below named inventor, I hereby declare that:

the specification of which

My residence, post office address and citizenship are as stated below next to my name and that I believe I am an original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled

METHOD OF FABRICATING INTER-LAYER SOLID CONDUCTIVE RODS

was filed on				
as Application Serial No.		and was amended on		
edification, including the I acknowledge the optication in accordance I hereby claim foreigolication(s) for patent or	claims, as amended duty to disclose information with Title 37, Code of in priority benefits und inventor's certificate	nd understand the content by any amendment referred mation which is material to Federal Regulations, § 1.5 der Title 35, Untied States C listed below and have also is ving a filing date before that:	to above. the patenta 6(a). ode, § 119 dentified bela	ability of of any fo
ority is claimed:	remoi s certificate hav	ving a ning date before that	от тпе аррис	ation on t
or Foreign Application(s	i):			
Number	Country	Date Filed(yyyy/mm/dd)	Yes	No
				X
	Patent and Tradema) Chanette Armstrong		39,081) 44,011)
				30,302)
SEND CORRESPOND	ENCE TO:	DIRECT TELEPHO (Name and teleph		то:

COMBINED DECLARATION AND POWER OF ATTORNEY CONTINUED

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patents issued thereon.

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